

## Quarterly Reliability Monitoring Results

Quarters: Q1/2021 to Q4/2021

Based on structural similarity

| Supplier                  |   | User Part Number                   |           |            |           |  |
|---------------------------|---|------------------------------------|-----------|------------|-----------|--|
| Nexperia B.V.             |   | BZX884S-C3V0                       |           |            |           |  |
| Name of Laboratory        |   | Part Description                   |           |            |           |  |
| Assembly reliability labs |   | Nexperia DHAM Zener<br>MCD package |           |            |           |  |
| Test                      | Test Conditions   | Duration                           | # Lots    | # Quantity | # Rejects |  |
| # 1                       | <b>TEST</b><br>Pre- and Post-Stress<br>Electrical Test<br>Tamb = 25 °C  | N/A                                | see below | all parts  | see below |  |
| # 2                       | <b>PC</b><br>Preconditioning<br>JESD22-A113<br>Bake Tamb = 125 °C<br>Soak Tamb = 85 °C, RH = 85%<br>Reflow soldering  | 24 hours<br>168 hours<br>3 cycles  | 113       | 9040       | 0         |  |
| # 5                       | <b>HTRB</b><br>High Temperature Reverse<br>Bias<br>MIL-STD-750-1<br>M1038 Method A<br>Tj = Tjmax, Vr = 100% of max. datasheet<br>reverse voltage              | 1000 hours                         | 138       | 11040      | 0         |  |
| # 5c                      | <b>SSOP</b><br>Steady State Operational<br>MIL-STD-750-1<br>M1038 Method B<br>Tj = Tjmax, Iz = 100% of max. datasheet<br>reverse current                      | 1000 hours                         | 20        | 1600       | 0         |  |
| # 7                       | <b>TC</b><br>Temperature Cycling<br>JESD22-A104<br>-65 °C to Tjmax, not to exceed 150°C   | 1000 cycles                        | 28        | 2240       | 0         |  |
| # 8                       | <b>AC</b><br>Autoclave<br>JESD22-A102<br>Tamb = 121 °C, RH = 100 %<br>Pressure = 205 kPa (29.7 psia)  | 96 hours                           | 28        | 2240       | 0         |  |
| # 9                       | <b>H3TRB</b><br>High Humidity High<br>Temperature Reverse Bias<br>JESD22-A101<br>Tamb = 85 °C, RH = 85%, VR = 80 % of<br>rated reverse voltage <sup>[1]</sup> | 1000 hours                         | 28        | 2240       | 0         |  |
| # 10                      | <b>IOL</b><br>Intermittent Operating Life<br>MIL-STD-750 Method 1037<br>ton = toff, devices powered to insure ΔTj =<br>100 °C for 15000 cycles                | 1000 hours                         | 29        | 2320       | 0         |  |
| # 20                      | <b>RSH</b><br>Resistance to Solder Heat<br>JESD22-A111<br>260 °C ± 5 °C   | 10 s                               | n.a.      | n.a.       | n.a.      |  |
| # 21                      | <b>SD</b><br>Solderability<br>J-STD-002   |                                    | 63        | 630        | 0         |  |

[1] The maximum applied voltage is limited by test chamber set up and does not exceed 115V.

### Calculation of FIT and MTF

Test considered for FIT calculation: High Temperature Reverse Bias (HTRB, Test # 5)

Confidence level 60%, derated to 55 °C, activation energy 0.7 eV, test time 168 to 1000 hours

| Wafer Fab        | Technology | Quantity | Rejects | Failure Rate (FIT) | MTTF (hrs) |
|------------------|------------|----------|---------|--------------------|------------|
| Nexperia<br>DHAM | Zener      | 11040    | 0       | 0.38               | 2.60E+09   |

© 2022 Nexperia B.V.

All information hereunder is per Nexperia's best knowledge. This document does not provide for any representation or warranty express or implied by Nexperia. In case Nexperia has tested the product, this documentation reflects the outcome of the analysis of the actually tested parts only.

[nexperia.com](http://nexperia.com)